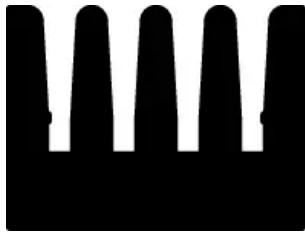


Data sheet Product ICK SMD F 26 MI



Heatsinks and active heatsinks for processors>Heatsinks for DIL-IC, PLCC and SMD

8 x 6 mm, for SMD components and others

Features

width:	8 mm
height:	6 mm
plate thickness:	2 mm
length:	26 mm
thermal resistance:	26 K/W
surface:	solderable surface

Technical Drawing

